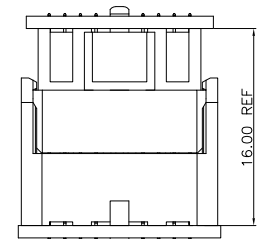
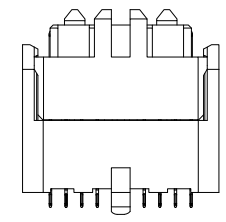
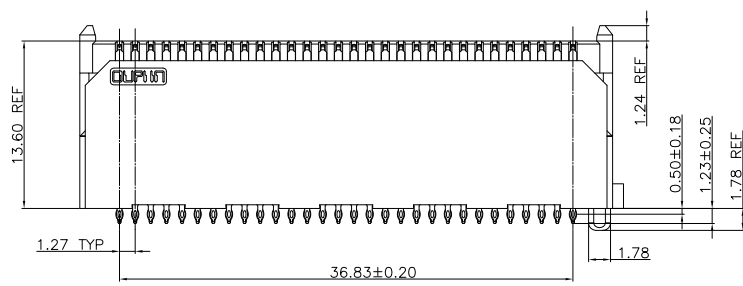
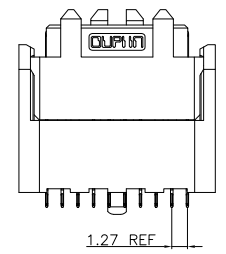
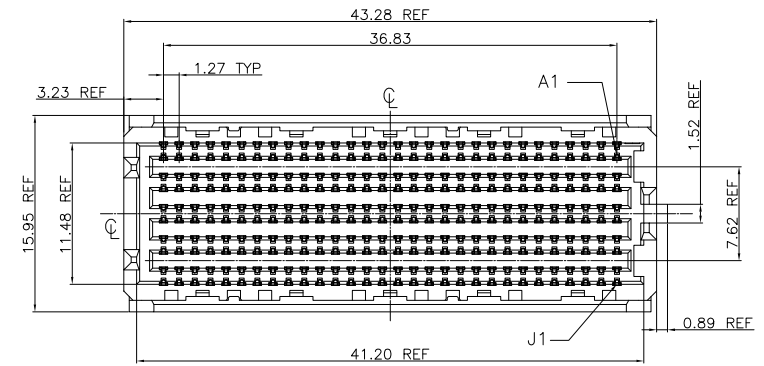
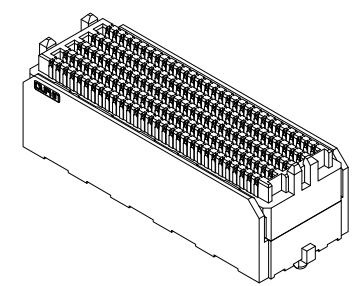


REV.	SPECIFICATION	ECN NO.	APPD.
R2		ECN211227	

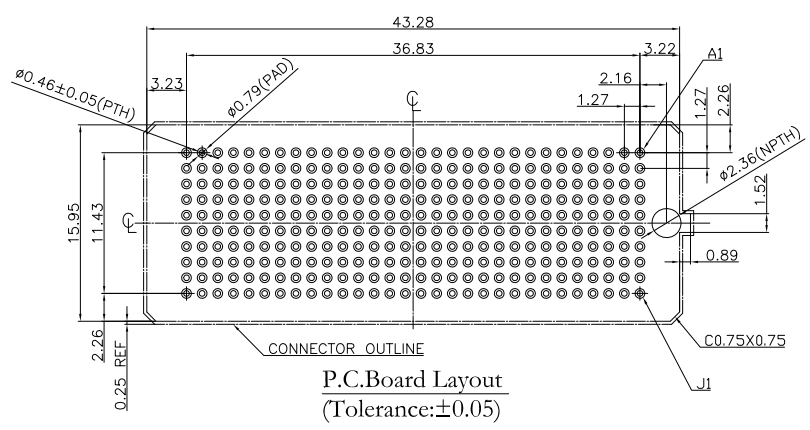
Material and Plating:
Housing: LCP, UL94V-0, Black.
Signal Contacts :Phosphor Bronze.
30u"Au+Pd/Ni on Contact Area and 80u" Min Tin Plated on Press Fit over nickel 50u" Min .

Electrical Characteristics:
Current Rating: Signal Pin: 2.7A.
Voltage Rating: 240V AC .
Dielectric Withstanding Voltage: 500V AC For 1 minute.
Insulator Resistance: 5000MΩ min at DC 500V.
Contact Resistance: Signal: 45mΩ max .
Operating Temperature: -55°C ~ +125°C .

***RoHS Compliant**



Mating Height



Series: 2322-
Row: 10 X 30
Position Per Row: M B 7 P P 3 A
M: Male
B: Dip Tin Plated
Contact Au+Pd/Ni Plated
7: 30μ"
T: Tape & Reel Package
U: Tube Package
A: Tray Package
3: Code 3 height 14.84mm
N: W/O Post
P: With Post
P: Press Fit Type

Tolerances	Dwg. No.	2322-D0000-008	Title:		 OUPIN ELECTRONIC(KUNSHAN) CO., LTD. P/N: 2322-10X30MB7PP3A
x = ±0.5	Projection		2322 Series		
.x = ±0.25	Unit	mm	Scale	1:1	
.xx = ±0.15	Drawn By	WP 12/21'21	High Speed Board to Board Pitch 1.27mm		SHEET 1/1
					Ver. No. R2